#### TSG-RAN Working Group 1 meeting #16

Pusan, Korea, October 10-13, 2000

**Agenda Item:** AH21 **Source:** CWTS

To: TSG RAN WG1

Title: Modulation and combination of physical channels in the

1.28 Mcps TDD

**Document for:** Decision

## 1. Summary

The section 7.6 has been copied from 3.84 Mcps TDD (version 3.4.0 including the Gain factors) and slightly modified since in the downlink there is no combination of the synchronisation channel and other physical channels, like in 3.84Mcps TDD.

### 2. Proposal

We propose to modify the following paragraphs in the working CR for the TS25.223 as the description of the modulation for the 1.28Mcps TDD.

# 7.6 Modulation for the 1.28 Mcps TDD

The complex-valued chip sequence is modulated as shown in figure [X3].

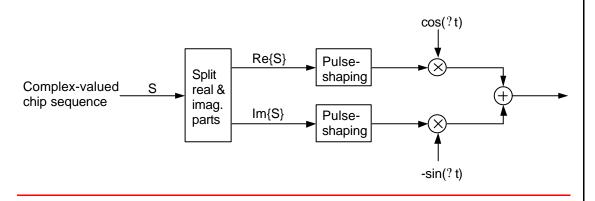


Figure [X3]: Modulation of complex valued chip sequences

The pulse-shaping characteristics are described in [9] and [10].

### 7.6.1 Combination of physical channels in uplink

The combination of physical channels in uplink is the same as in the 3.84 Mcps TDD cf. [6.5.1 Combination of physical channels in uplink]

### 7.6.2 Combination of physical channels in downlink

The combination of physical channels in downlink is the same as in the 3.84 Mcps TDD cf. [6.5.2 Combination of physical channels in downlink]

------ Changes to working CR of 25.223 end -----